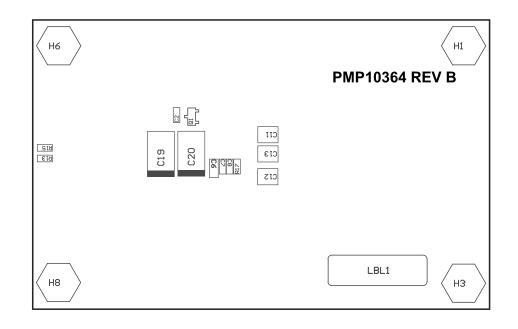


## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10364	REV: B	SUN REU	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 1/25/2	2016 5: 42: 52	PM	TEXAS INSTRUMENTS



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10364	REV: B	SVN REV: Not In VersionControl		
	Bottom Overlay <- JACHOI				
PLOT NAME = Bottom Assembly Drawing	GENERATED : 1/25/2	2016 5: 42: 53	PM	TEXAS INSTRUMENTS	

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